

PCB Design with KiCad

Introduction and Guidance

for Physicists at HIM

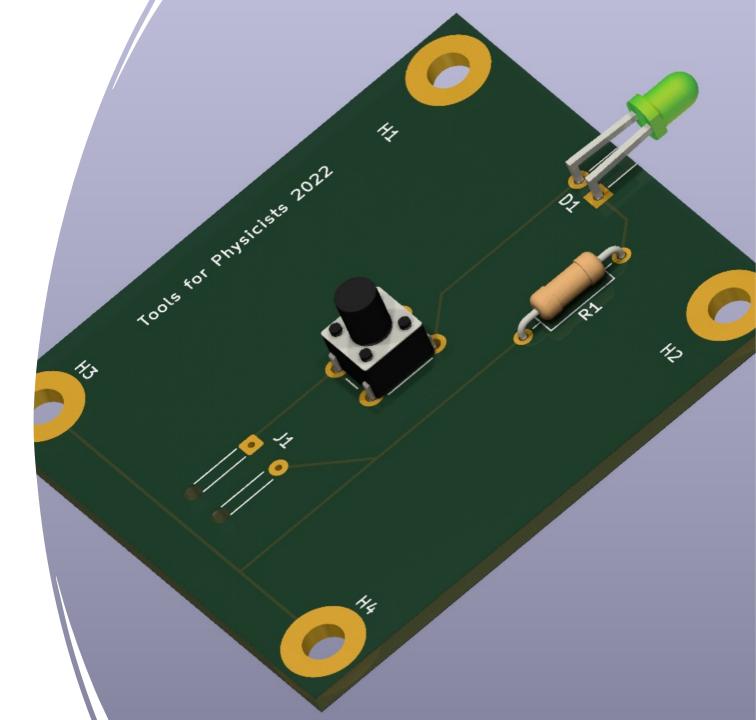
5.7.2023 – Peter-Bernd Otte - HI-Mainz

Our overall goal today

• Design and produce a printed circuit board (PCB)!

PCB:

- 1. affix electronic components
- 2. electrical connections



What is achievable? Do not start if...

If you strive for ...

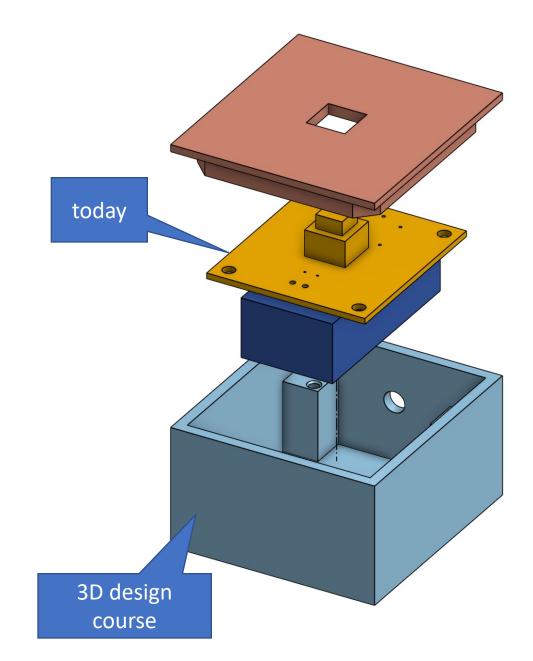
- high currents
- high voltages
- high frequencies
- multi layer PCB

- >1A \rightarrow hot traces or contacts
- >42V \rightarrow induce ventricular fibrillation
- >20 MHz \rightarrow impedance becomes important
- >4 layers ightarrow complicated
- small / complicated parts \rightarrow hard to solder
- large number of boards → usage of panels (German: "Nutzen")
- → contact the electronics workshop at KPH (Igor Beltschikow and crew)

Focus today: slow control

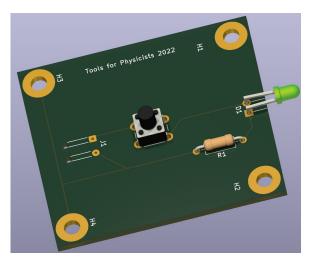
Today's overview

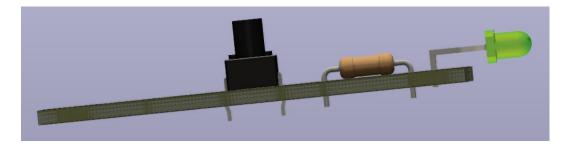
- THT, SMD / Reflow soldering / PCB properties
- 2. PCB design software overview
- 3. KiCAD's advanced functionality showcase
- 4. 1st KiCAD project: a flash light
- 5. custom symbols and footprints
- 6. bonus project: lab environment slow control

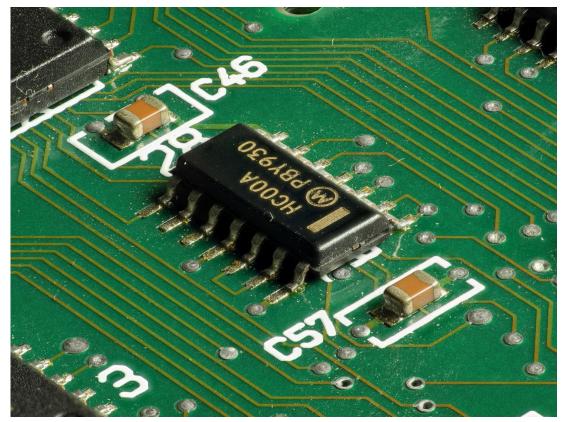


1) THT and SMD

• Through hole technology (THT) and Surface Mount Device (SMD)







Von Thomas Bresson - Eigenes Werk, CC BY 3.0, https://commons.wikimedia.org/w/index.php?curid=23740567

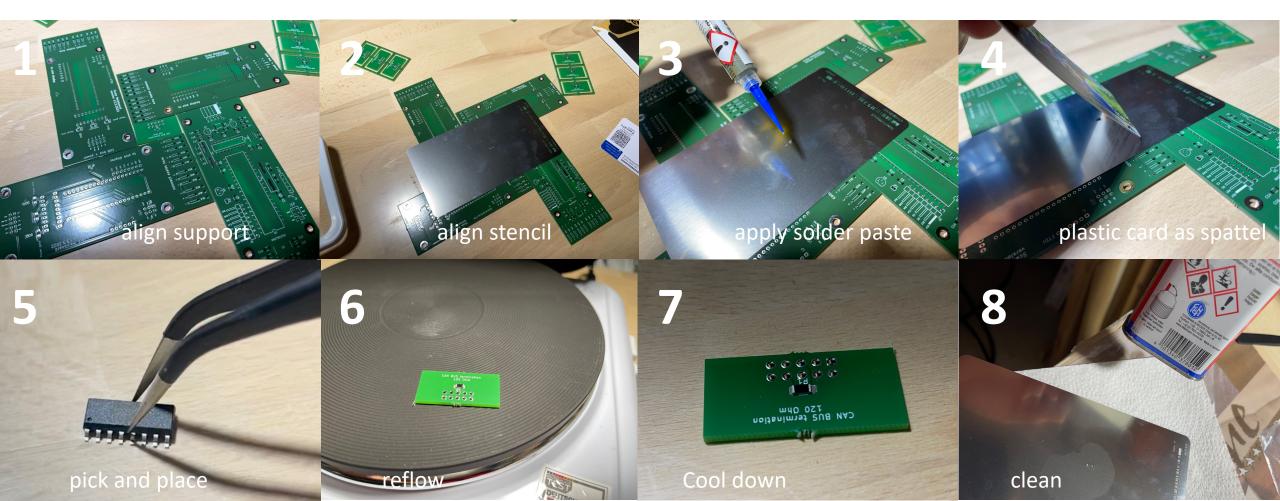
Reflow

• Good how to: reflow by hand: https://www.sparkfun.com/tutorials/58

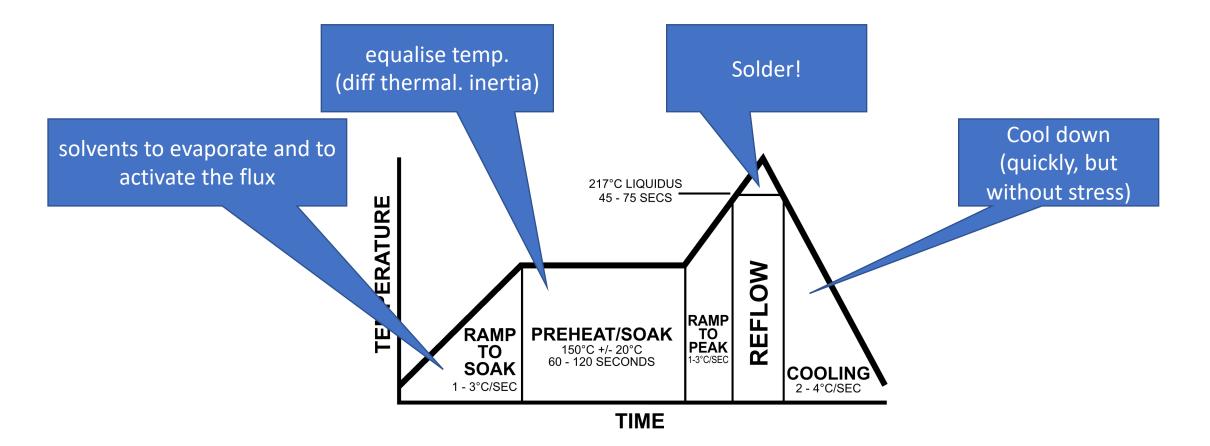




Reflow step by step



Reflow profile characteristics

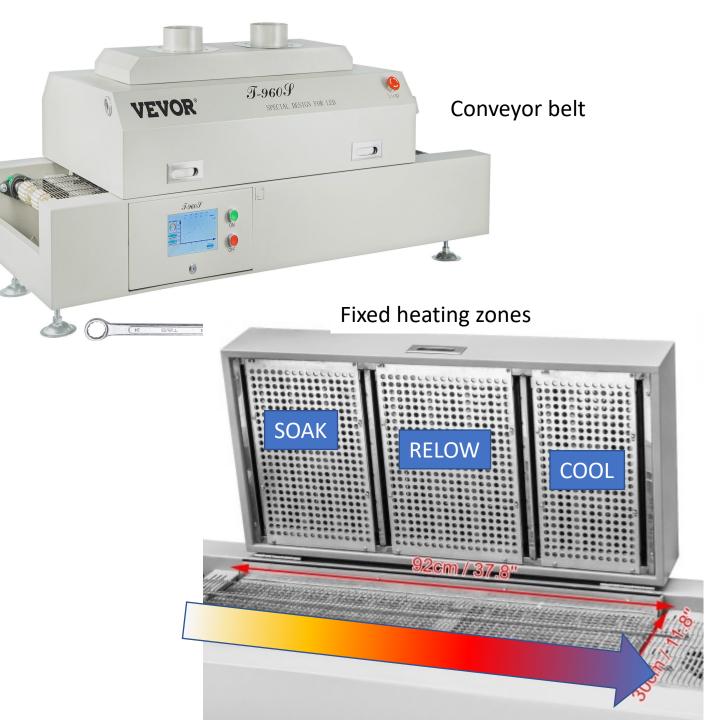


Reflow Ovens



eC-reflow-mate V4 from eurocircuits

time dependent temperature



Arbitrary PCB shapes and holes

PCB Christmas Tree https://electronoobs.com/PCB_prototype17.php



ARDUBEE, http://luminousbe.es/ardubee/

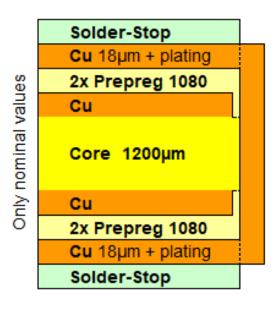


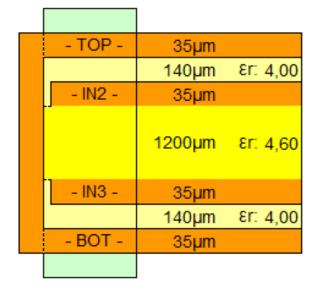
PCB properties

- Material: FR-4 (standard), aluminium, copper base, etc.
- Flexible, High frequency, high thermal loads, etc.
- Layer buildup for PCBs

multi-circuit-boards.eu







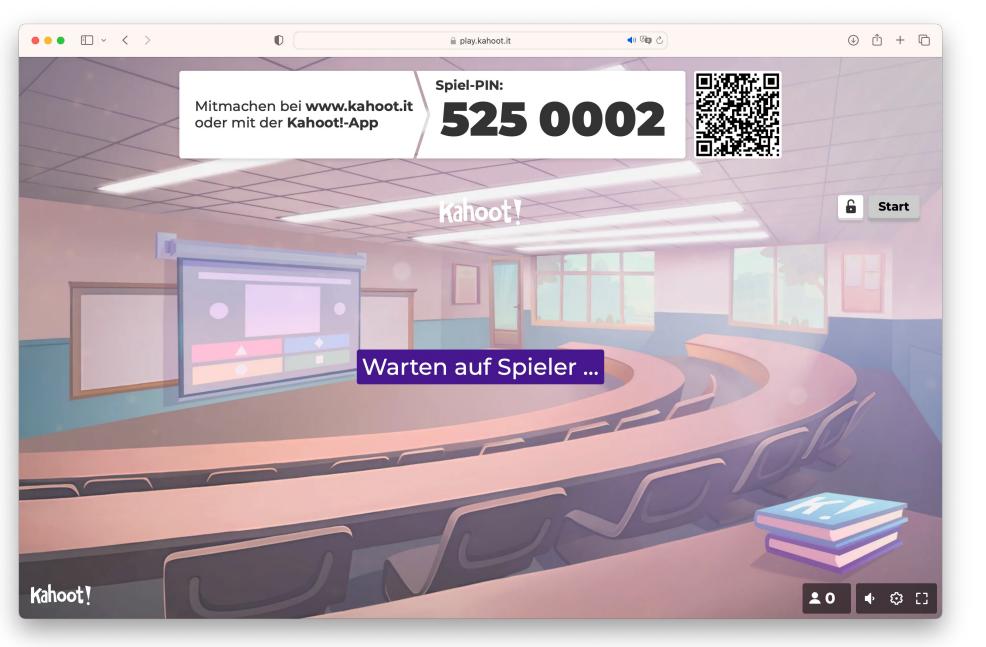
Example PCB build up from eurocircuits.com

Material				Buildup	
Number of layers	4 Y Board thick	ness 1.55 mm	~		
Reversed buildup	Base mater	FR-4 Impro	oved ~		Top legend Top soldermask
Blind/Buried via runs	0 Extra press cycles	0			Top copper Prepreg - PR7628 - 0.18mm
Special buildup	Defined impedance				Prepreg - PR7628 - 0.18mm Inner copper 1
Available buildups					Corp. 504 Improved 0.71mm
ore thickness	Outer layer copper foil	Inner layer copper			Core - FR4-Improved - 0.71mm
0.710 mm	12 μm (end 30 μm)	12 µm	9		
0.710 mm	12 µm (end 30 µm)	18 µm			Inner copper 2
0.710 mm	18 μm (end 35 μm)	18 µm			Prepreg - PR7628 - 0.18mm
0.710 mm	18 µm (end 35 µm)	35 µm			Prepreg - PR7628 - 0.18mm
0.710 mm	35 μm (end 60 μm)	35 µm			Bottom copper
0.710 mm	35 μm (end 60 μm)	70 µm	9		 Bottom soldermask Plated drill
0.710 mm	70 μm (end 95 μm)	70 µm	9		 Non Plated Through Hole (NPTH)
0.360 mm	12 µm (end 30 µm)	12 µm	9		
0.360 mm	12 μm (end 30 μm)	18 µm	9		
0.360 mm	18 μm (end 35 μm)	18 µm	9		
0.360 mm	18 µm (end 35 µm)	35 µm	9		
0.360 mm	35 μm (end 60 μm)	35 µm	9		
0.360 mm	35 μm (end 60 μm)	70 µm	9		
0.360 mm	70 μm (end 95 μm)	70 µm	9		
0.200 mm	12 μm (end 30 μm)	12 µm	9		
0.200 mm	12 µm (end 30 µm)	18 µm	9		
0.200 mm	18 µm (end 35 µm)	18 µm	9		
0.200 mm	18 μm (end 35 μm)	35 µm	9		
0.200 mm	35 μm (end 60 μm)	35 µm	9		
0.200 mm	35 μm (end 60 μm)	70 µm	9		
0.200 mm	70 μm (end 95 μm)	70 µm	9	Total material thickne	4.500

Board Setup

PCB Editor: File > Board Setup ← match it with PCB manufacturer

 Board Stackup Board Editor Layers 	Copper	layers: 2 🔇	9	Impedance co	ntrolled	ł		Add Dielectric Layer		Remove Diele	ectric Layer
Physical Stackup	Layer	Id	Туре	Material		Thickness	•	Color		Epsilon R	Loss Tan
Board Finish Solder Mask/Paste		F.Silkscreen	Top Silk Screen	Not specified				Not specified	~		
 Text & Graphics 		F.Paste	Top Solder Paste								
Defaults Text Variables		F.Mask	Top Solder Mask	Not specified		0.01 mm		Not specified	•	3.3	0
 Design Rules Constraints 	_	F.Cu	Copper			0.035 mm					
Pre-defined Sizes		Dielectric 1	Core 📀	FR4		1.51 mm				4.5	0.02
Net Classes Custom Rules		B.Cu	Copper			0.035 mm					
Violation Severity		B.Mask	Bottom Solder Mask	Not specified		0.01 mm		Not specified	•	3.3	0
		B.Paste	Bottom Solder Paste								
	—	B.Silkscreen	Bottom Silk Screen	Not specified				Not specified	•		



https://create.kahoot.it/creator/f46b0b61-21d1-4e46-8356-bedb784061e2

2) PCB design software overview

KiCAD import from other tools:

- Altium Circuit Maker/Studio / Designer
- CADSTAR

3) KiCAD's advanced functionality showcase: impedance

- Calculate trace width: project window -> calculator tools.
- See PCB manufacturer for parameters
- Ground layer underneath
- Not needed for today's slow control problem class

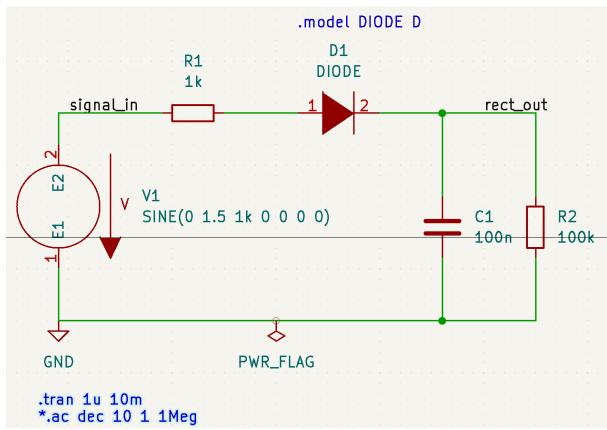
•••				PCB	-Rechner			
	Regler RF-Dämp	ofungsglieder E-Serie	Farbcode	TransLine	Via-Größe	Leiterbah	hnbreite Elektrische Abstände Platinenklassen	
Übertragungsleitungstyp		Parameter Trägermaterial					Physikalische Parameter	
Microstrip Leiter Koplanarer Wellenleit Koplanarer Wellenleit	er er mit Massefläche	εr: tan δ:	4,6 0,02				W: 0,349579 mm (L: 48,3109 mm (
Rechteckiger Leiter			p: 1,72e-08 H: 0,2 p): 1e+20 T: 0,035			mm 📀 mm 📀 mm 📀		
Gekoppelte Microstri Streifenleitung	o-Leiter	H(top):					Analysiere Synthetisieren Synthetisieren	
Twisted Pair		Oberflächenrauheit: µ(Substrat):				mm 😒		
		μ(Leiter):	1				Ang_1: 1,81405 rad (2
		Bauteilparameter Frequenz: 1				GHz ᅌ	Ergebnisse Effektive εr: 3,20988 Leitungsverluste: 0,127528 dB Dielektrische Verluste: 0,138577 dB Eindringtiefe: 2,0873 μm	

PSPICE simulation example

- See: "Pspace example"
- Run: "Inspect > Simulator"
 - 1. Hit "play" button
 - 2. Add signals

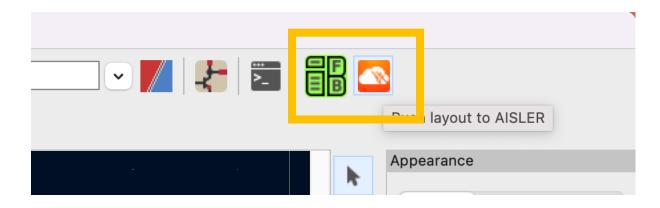
Hint on pin numbering:

 If inconsistent change via "Alternate node sequence" in "Properties" -> "Spice Model Editor"



Plugins (1/2): Aisler Push

- One click upload and PCB order
- Aisler = KiCAD platinum sponsor



1284pTest2

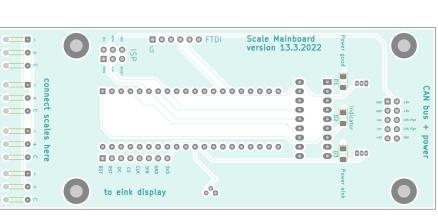
Rev:

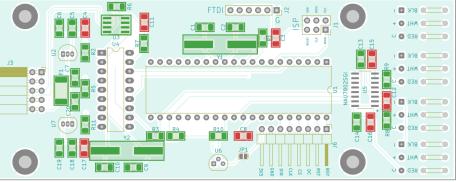
2022-03-13 15:31:29

0 F FB в

Plugins (2/2): HTML BOM

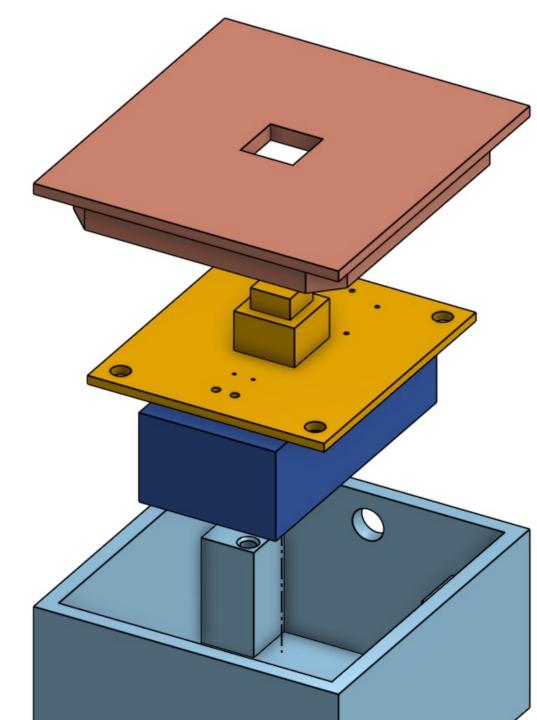
Y	Ref	look	up		Y Filter
000	Sou rce d	Pla ced	Quanti ty	Value	References
1			8	100n	C3, C4, C8, C11, C12, C15, C16, C17
2			5	1µ	C6, C7, C14, C19, C20
3			4	22pF	C1, C2, C9, C10
4			2	10µ	C5, C18
5			1	330p	C13
6			3	120	R2, R5, R11
7		✓	2	10k	R1, R7
8			2	2.2k	R3, R4
9		✓	2	47	R8, R9
10		✓	1	1k	R6
11		✓	1	4.7k	R10
12			3	LED	D1, D2, D3
13			2	MCP1700- 3302E_T092	U2, U7
14			1	ATmega1284P -P	U1
15			1	SN65HVD230	U3
16			1	MCP2515	U4
17			1	NAU7802SGI	U5
18			1	DS18B20	U6
19		v	1	12MHz	Y1
20		✓	1	8MHz	Υ2
21		v	1	Fuse/Polyfu se 500mA	F1
22			1	SolderJumpe r_2_Open	JP1
23			4	Conn_01x03_ Male	J4, J5, J7, J8
24			1	AVR-ISP-6	J1
25			1	Conn_01x06	J2
26			1	Conn_02x05_ 0dd_Even	J3
27			1	Conn_01x08	J6





4) 1st project: Flash light

- (in cooperation with 3D design)
- Think of an amplifier in a box, but for today's problem class a bit simpler
- https://cad.onshape.com/documents/f3df22f41f5956 c250e92d72/w/e39ec1ee5ab3727597d41460/e/9d99 f21896da01cb25f775fc?renderMode=0&uiState=62a8 a9478ac6385651dec014



Since 2020: new procedure

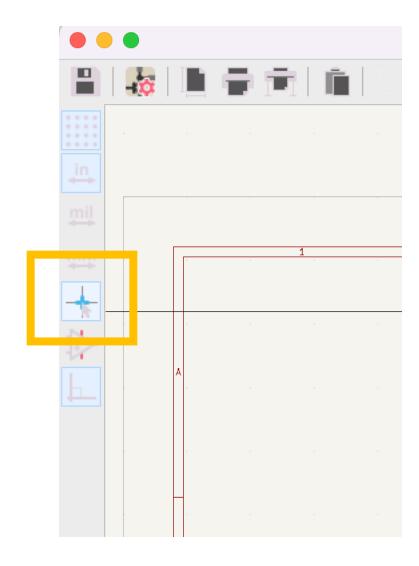
Treat delivery dates > 1 week as infinite.

- 1. buy ALL parts
 - 1. Not avail? Check different package
 - 2. Alternative distributor?
 - 3. But reliable, eg via <u>https://octopart.com</u> otherwise fraud possible. Often: used or "relabelled" part (eg 5A MOSFET becomes 10A version simply by changing the label)
- 2. Start layout / PCB

Hints for preferences

• Schematic-/PCB-Editor: "Always show crosshairs" for mouse pointer

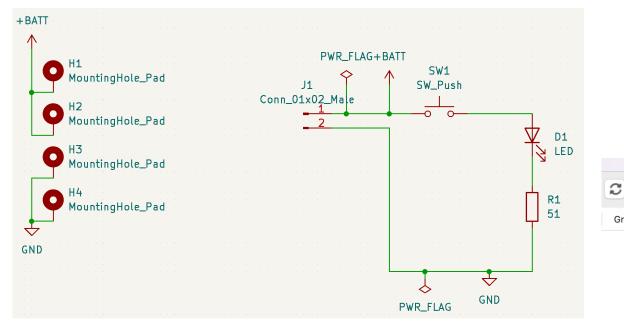
 PCB-Editor: enable "Show ratsnets with curved lines"

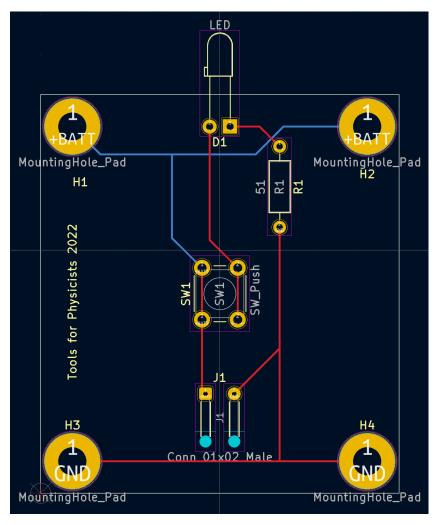


The design starts now!

- Together, step by step: basic concepts and workflow
- Alternatively:

https://docs.kicad.org/7.0/en/getting_started_in_kicad/getting_started_in_kicad.html





Sympol Fields Table

C	Reference	Value	Footprint	Datasheet	Qty
	D1	LED	LED_THT:LED_D3.0mm_Horizontal_06.35mm_Z2.0mm	~	1
Grou	> H1-H4	MountingHole_Pad	MountingHole:MountingHole_3.5mm_Pad	~	4
- <u>F</u>	J1	Conn_01x02_Male	Connector_Wire:SolderWire-0.1sqmm_1x02_P3.6mm_D0.4mm_O	~	1
	R1	51	Resistor_THT:R_Axial_DIN0207_L6.3mm_D2.5mm_P10.16mm_Ho	~	1
Ċ	SW1	SW_Push	Button_Switch_THT:SW_PUSH_6mm_H8mm	~	1

Typical DRC error messages and their solution

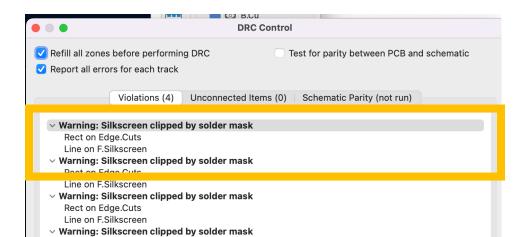
- Spot for hidden traces. Sometimes stubs are hidden behind other lines.
 - Warning: Track has unconnected end

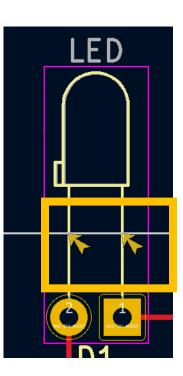
Track [GND] on F.Cu, length 1.0000 mm

 Warning: Silkscreen clipped by solder mask Rect on Edge.Cuts

Line on F.Silkscreen

- Warning: Silkscreen clipped by solder mask Rect on Edge.Cuts
- Look out for the yellow arrows to locate DRC errors.





5) Custom Symbols and Footprints

- (Not for today's problem class)
- Detailed and up to date tutorial by the makes of KiCAD: <u>https://docs.kicad.org/7.0/en/getting_started_in_kicad/getting_start</u> <u>ed_in_kicad.html</u>

3 step process:

- 1. Create new symbols
- 2. Create new footprints
- 3. Linking symbols, footprints and 3D models

6) Bonus project: Wifi Lab environment Slow Control

- Submit with ESP 8266 data via WLAN SSID winulum to MQTT broker on campus
- Hints:
 - Make as many components equal, if possible (R 4,7 and R 10k-> R4,7)
 - Look into the datasheet of the components used what they need additionally.
 - Think of EM environment: Better smaller pull up/down than power savings.

				+50	V	5						
Bauteil : Fo	otprint Zuoro	dnungen	J3 USB_B_Micro		C347222 AMS1117-3							
1	C1 -	100 nF : Capacitor_SMD:C_0805_2012Metric 🖉				<u>۲</u>		•	_			
2	C2 -	100 nF : Capacitor_SMD:C_0805_2012Metric							CG R4 2.2k	75 17 17 10k		
3	C3 -	100 µF : Capacitor_Tantalum_SMD:CP_EIA-6032-28_Kemet-C	a a a a a a a a a a a a a a a a a a a								5W2	
4	C4 -	<pre>10 µF : Capacitor_Tantalum_SMD:CP_EIA-3528-12_Kemet-T</pre>						C1752(R3 2.2k ES	U2 77 R5 5P-12F 75 10k	SW2 SW_flash	Conn_01x04_Male J4
5	C5 -	22 μF : Capacitor_Tantalum_SMD:CP_EIA-3216-12_Kemet-S									2 8 3	4 M M +
6	J3 -	USB_B_Micro : Connector_USB:USB_Micro-B_Wuerth_629105150521					100 nF		3 EN	GPI01/TXD 22 GPI02 17 21	C285	
7	J4 -	Conn_01x04_Male : Connector_PinHeader_2.54mm:PinHeader_1x04_P2.54mm_Vertical							× ² adc	GPI03/RXD 21 GPI04 19 GPI04 20		
8	R1 -	4,7k : Resistor_SMD:R_0805_2012Metric					C49678 - 100 nF		×9 C50 C8	82891 GPI012 6		
9	R2 -	4,7k : Resistor_SMD:R_0805_2012Metric				Г	C2		11 GPI09	GPI015 GPI014 GPI015 16		
10	R3 -	2.2k : Resistor_SMD:R_0805_2012Metric					. C49678			GPI016 4× ·		
11	R4 -	2.2k : Resistor_SMD:R_0805_2012Metric								15		
12	R5 -	10k : Resistor_SMD:R_0805_2012Metric					Į Į	ск 4 5 4.7к				
13	R6 -	10k : Resistor_SMD:R_0805_2012Metric				E	BME280 C92489					
14	R7 -	10k : Resistor_SMD:R_0805_2012Metric					UND UND	SB 2 4,7k		*T R7		
15	SW1 -	SW_reset : Button_Switch_THT:SW_PUSH_6mm_H5mm							N - SW1	22 G4	00 µF	
16	SW2 -	SW_flash : Button_Switch_THT:SW_PUSH_6mm_H5mm					•	C.	285489 SW_reset	1	4	
17	Ul -	BME280 : Package_LGA:Bosch_LGA-8_2.5x2.5mm_P0.65mm_ClockwisePinNumbering	•							· · · · · · · · · · · · · · · · · · ·	• •	
18	U2 -	ESP-12F : RF_Module:ESP-12E										
19	U3 -	AMS1117-3.3 : Package_TO_SOT_SMD:SOT-223-3_TabPin2	GND									